

大睿股份有限公司

RoHS 限用物質含有量標示

1	型號：A001 系列型號：BSC10UD，BSC10UC，BSC10E 外接式電源供應器 DA-52C24	第1頁 第12頁
2	型號：A006 系列型號：mPOP, POP10, POP10CI 外接式電源供應器 ATS065-P241	第2頁 第13頁
3	型號：TSP100 系列型號：TSP143IIIU，TSP143IIILAN	第3頁
4	型號：TSP650 系列型號：TSP654IIC, TSP654IIE3, TSP654IID, TSP654IIU, TSP654IIE3X, TSP654IIBI2, TSP654IIHIX . 外接式電源供應器 DA-52C24	第4頁 第12頁
5	型號：TSP700 系列型號：TSP743IIC, TSP743IIE3, TSP743IID, TSP743IIU, TSP743IIE3X, TSP743IIBI2, TSP743IIHIX . 外接式電源供應器 DA-52C24	第5頁 第12頁
6	型號：TUP500 系列型號：TUP592C, TUP592D, TUP592U, TUP592E3, 外接式電源供應器 DA-52C24	第6頁 第12頁
7	型號：MCP20 外接式電源供應器 DA-52C24	第7頁 第12頁
8	型號：MCP31L 系列型號：MCP30 外接式電源供應器 DA-52C24	第8頁 第12頁
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設備名稱：熱感式印表機 型號：A001（系列：BSC10UD , BSC10UC , BSC10E）

單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr+6)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
外殼Enclosure	○	○	○	○	○	○
機構Mechanism	-	○	○	○	○	○
電路板總成 Printed circuit board	-	○	○	○	○	○
電源供應器Power supply	○	○	○	○	○	○
包裝Packages	○	○	○	○	○	○

備考1. “超出0.1 wt %” 及 “超出0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值。

Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.

備考2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。

Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.

備考3. “-” 係指該項限用物質為排除項目。

Note 3: The “-” indicates that the restricted substance corresponds to the exemption.

設備名稱：熱感式印表機 型號：A006（系列：mPOP,POP10,POP10CI）

單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr+6)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
外殼Enclosure	○	○	○	○	○	○
機構Mechanism	-	○	○	○	○	○
電路板總成 Printed circuit board	-	○	○	○	○	○
電源供應器Power supply	○	○	○	○	○	○
包裝Packages	○	○	○	○	○	○

備考1. “超出0.1 wt %”及“超出0.01 wt %”係指限用物質之百分比含量超出百分比含量基準值。

Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.

備考2. “○”係指該項限用物質之百分比含量未超出百分比含量基準值。

Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.

備考3. “-”係指該項限用物質為排除項目。

Note 3: The “-” indicates that the restricted substance corresponds to the exemption.

設備名稱：熱感式印表機 型號：TSP100（系列：TSP143IIIU，TSP143IIILAN）

單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr+6)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
外殼Enclosure	○	○	○	○	○	○
機構Mechanism	-	○	○	○	○	○
電路板總成 Printed circuit board	-	○	○	○	○	○
電源供應器Power supply	-	○	○	○	○	○
包裝Packages	○	○	○	○	○	○

備考1. “超出0.1 wt %”及“超出0.01 wt %”係指限用物質之百分比含量超出百分比含量基準值。

Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.

備考2. “○”係指該項限用物質之百分比含量未超出百分比含量基準值。

Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.

備考3. “-”係指該項限用物質為排除項目。

Note 3: The “-” indicates that the restricted substance corresponds to the exemption.

設備名稱：熱感式印表機 型號：TSP650
 系列：TSP654IIC,TSP654IIE3,TSP654IID, TSP654IIU, TSP654IIE3X, TSP654IIBI2, TSP654IIHIX

單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr+6)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
外殼Enclosure	○	○	○	○	○	○
機構Mechanism	-	○	○	○	○	○
電路板總成 Printed circuit board	-	○	○	○	○	○
電源供應器Power supply	○	○	○	○	○	○
包裝Packages	○	○	○	○	○	○

備考1. “超出0.1 wt %” 及 “超出0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值。

Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.

備考2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。

Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.

備考3. “-” 係指該項限用物質為排除項目。

Note 3: The “-” indicates that the restricted substance corresponds to the exemption.

設備名稱：熱感式印表機 型號：TSP700 系列：TSP743IIC,TSP743IIE3,TSP743IID, TSP743IIU, TSP743IIE3X, TSP743IIBI2, TSP743IIHIX						
單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr+6)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
外殼Enclosure	○	○	○	○	○	○
機構Mechanism	-	○	○	○	○	○
電路板總成 Printed circuit board	-	○	○	○	○	○
電源供應器Power supply	○	○	○	○	○	○
包裝Packages	○	○	○	○	○	○
備考1. “超出0.1 wt %” 及 “超出0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值。 Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition. 備考2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。 Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence. 備考3. “-” 係指該項限用物質為排除項目。 Note 3: The “-” indicates that the restricted substance corresponds to the exemption.						

設備名稱：熱感式印表機 型號：TUP500 系列：TUP592C,TUP592D,TUP592U,TUP592E3,						
單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr+6)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
機構Mechanism	-	○	○	○	○	○
電路板總成 Printed circuit board	-	○	○	○	○	○
電源供應器Power supply 型號：DA-52B24	○	○	○	○	○	○
電源供應器Power supply 型號：DA-52C24	-	○	○	○	○	○
包裝Packages	○	○	○	○	○	○
備考1. “超出0.1 wt %” 及 “超出0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值。 Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition. 備考2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。 Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence. 備考3. “-” 係指該項限用物質為排除項目。 Note 3: The “-” indicates that the restricted substance corresponds to the exemption.						

設備名稱：熱感式印表機 型號：MCP20

單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻Hexavalent chromium (Cr+6)	多溴聯苯Polybrominated biphenyls (PBB)	多溴二苯醚Polybrominated diphenyl ethers (PBDE)
外殼Enclosure	○	○	○	○	○	○
機構Mechanism	○	○	○	○	○	○
電路板總成 Printed circuit board	-	○	○	○	○	○
電源供應器Power supply	-	○	○	○	○	○
包裝Packages	○	○	○	○	○	○

備考1. “超出0.1 wt %” 及 “超出0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值。

Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.

備考2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。

Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.

備考3. “-” 係指該項限用物質為排除項目。

Note 3: The “-” indicates that the restricted substance corresponds to the exemption.

設備名稱：熱感式印表機 型號：MCP31L 系列：MCP30

單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻Hexavalent chromium (Cr+6)	多溴聯苯Polybrominated biphenyls (PBB)	多溴二苯醚Polybrominated diphenyl ethers (PBDE)
外殼Enclosure	○	○	○	○	○	○
機構Mechanism	-	○	○	○	○	○
電路板總成 Printed circuit board	-	○	○	○	○	○
電源供應器Power supply	-	○	○	○	○	○
包裝Packages	○	○	○	○	○	○

備考1. “超出0.1 wt %” 及 “超出0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值。

Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.

備考2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。

Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.

備考3. “-” 係指該項限用物質為排除項目。

Note 3: The “-” indicates that the restricted substance corresponds to the exemption.

設備名稱：熱感式印表機 型號：TSP100A 系列：TSP100IV , TSP143IV-UE

單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr+6)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
外殼Enclosure	○	○	○	○	○	○
機構Mechanism	-	○	○	○	○	○
電路板總成 Printed circuit board	-	○	○	○	○	○
包裝Packages	○	○	○	○	○	○

備考1. “超出0.1 wt %” 及 “超出0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值。

Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.

備考2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。

Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.

備考3. “-” 係指該項限用物質為排除項目。

Note 3: The “-” indicates that the restricted substance corresponds to the exemption.

設備名稱：熱感式印表機 型號：MCP21LB

單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻Hexavalent chromium (Cr+6)	多溴聯苯Polybrominated biphenyls (PBB)	多溴二苯醚Polybrominated diphenyl ethers (PBDE)
外殼Enclosure	○	○	○	○	○	○
機構Mechanism	○	○	○	○	○	○
電路板總成 Printed circuit board	-	○	○	○	○	○
電源供應器Power supply	-	○	○	○	○	○
包裝Packages	○	○	○	○	○	○

備考1. “超出0.1 wt %” 及 “超出0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值。

Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.

備考2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。

Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.

備考3. “-” 係指該項限用物質為排除項目。

Note 3: The “-” indicates that the restricted substance corresponds to the exemption.

設備名稱：熱感式印表機 型號：MCL32CI						
單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr+6)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
外殼Enclosure	○	○	○	○	○	○
機構Mechanism	-	○	○	○	○	○
電路板總成 Printed circuit board	-	○	○	○	○	○
電源供應器Power supply	-	○	○	○	○	○
包裝Packages	○	○	○	○	○	○
備考1. “超出0.1 wt %” 及 “超出0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值。 Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition. 備考2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。 Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence. 備考3. “-” 係指該項限用物質為排除項目。 Note 3: The “-” indicates that the restricted substance corresponds to the exemption.						

設備名稱：電源供應器， Equipment name		型號（型式）：DA-52C24 Type designation (Type)				
單元 Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr ⁺⁶)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
外殼	○	○	○	○	○	○
線材	—	○	○	○	○	○
插座	—	○	○	○	○	○
印刷電路板 (含插件)	—	○	○	○	○	○
標籤	○	○	○	○	○	○
備考1. “超出0.1 wt %”及“超出0.01 wt %”係指限用物質之百分比含量超出百分比含量基準值。 Note 1 : “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.						
備考2. “○”係指該項限用物質之百分比含量未超出百分比含量基準值。 Note 2 : “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.						
備考3. “—”係指該項限用物質為排除項目。 Note 3 : The “—” indicates that the restricted substance corresponds to the exemption.						

設備名稱：交換式電源供應器，型號（型式）：ATS065-P241

Equipment name Type designation (Type)

單元 Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛 Lead (Pb)	汞 Mercury (Hg)	鎘 Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr ⁺⁶)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
上蓋	☐	☐	☐	☐	☐	☐
下蓋	☐	☐	☐	☐	☐	☐
電路板	☐	☐	☐	☐	☐	☐
插頭	☐	☐	☐	☐	☐	☐
線材	☐	☐	☐	☐	☐	☐
變壓器	☐	☐	☐	☐	☐	☐

備考 1. “超出 0.1 wt %” 及 “超出 0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值

Note 1 : “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.

備考 2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。

Note 2 : “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.

備考 3. “—” 係指該項限用物質為排除項目。

Note 3 : The “—” indicates that the restricted substance corresponds to the exemption.